

CRYSTAL OSCILLATOR (Programmable) OUTPUT: CMOS

SG-8101 series

• Frequency range: 0.67 MHz to 170 MHz (1 ppm Step)

• Supply voltage : 1.62 ∨ to 3.63 ∨

 Function : Output enable (OE) or Standby (ST)

• Frequency tolerance, operating temperature:

±15 ppm (-40 °C to +85 °C) ±20 ppm, ±50 ppm (-40 °C to +105 °C)

: 2.5 x 2.0, 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 (mm) Package

PLL technology to enable short lead time

• Available field oscillator programmer "SG-Writer II"





Product Number

SG-8101CA: X1G005191xxxx00 SG-8101CB: X1G005201xxxx00 SG-8101CE: X1G005211xxxx00 SG-8101CG: X1G005181xxxx00



CG







CB CA

Specifications (characteristics)

Iter	m	Symbol		Specifi	cations		Cor	Conditions/Remarks			
Supply voltage		Vcc	1.80 V Typ. 2.50 V Typ. 3.30 V Typ. 1.62 V to 1.98 V 1.98 V to 2.20 V 2.20 V to 2.80 V 2.70 V to 3.63 V								
Supply voltage		VCC	1.62 V to 1.98 V	1.98 V to 2.20 V	2.20 V to 2.80 V	-					
Output frequence	cy range	fo		0.67 MHz	to 170 MHz						
Storage temperature T_stg) +125 ℃		Storage as single p	product.			
Operating temp	erature	T use		-40 °C t	o +85 ℃			-			
operating temperature		1_000) +105 °C			<u> </u>			
					5 × 10 ⁻⁶		T_use = -40 °C to +				
Frequency toler	Frequency tolerance*1				0 × 10 ⁻⁶		T_use = -40 °C to +				
				1	0 × 10 ⁻⁶		T_use = -40 °C to +	+105 °C			
			3 2 mA Max.	3.3 mA Max.	3.4 mA Max.	3.5 mA Max.	T_use = +105 °C	No load, fo = 20 MHz			
Current consum	notion	Icc		nA Typ.	2.9 mA Typ.	3.0 mA Typ.	T_use = +25 °C				
	•		5 5 mA Max.	5.8 mA Max.	6.7 mA Max.	8.1 mA Max.	T_use = +105 °C	No load, fo = 170 MHz			
0 1 1 5 11				nA Typ.	5.7 mA Typ.	6.8 mA Typ.	T_use = +25 °C				
Output disable	current	I_dis	3 2 mA Max.	3.2 mA Max.	3.3 mA Max.	3.5 mA Max.	OE = GND, fo = 17	U MHZ			
Standby current	t	I std	0.9 µA Max.	1.0 µA Max.	1.5 µA Max.	2.5 μA Max. 1.1 μA Typ.	T_use = +105 °C	ST = GND			
Common et e		0)44	0.3 μA Typ.	0.4 μA Typ.	0.5 μA Typ.	T_use = +25 °C					
Symmetry		SYM		45 % 1	to 55 %	50 % V _{CC} Level					
							I _{OH} /I _{OL} Conditions Rise/Fall time	[mA]			
		VoH		90 % \	/cc Min.		Default (fo > 40 MHz)	 			
						Fast	loL 2.5 3.5 4.0 5.0				
Output voltage							Default (fo ≤ 40 MHz)	Іон -1.5 -2.0 -2.5 -3.0			
(DC characteris	stics)		10 % V _{CC} Max.				Belault (10 3 40 Wille)	lo _L 1.5 2.0 2.5 3.0			
		VoL					Slow	loн -1.0 -1.5 -2.0 -2.5 loь 1.0 1.5 2.0 2.5			
		VOL		10 70 ¥	CC WIGA.	*A: 1.62 V to 1.98 V, *B: 1.98 V to 2.20					
						*C: 2.20 V to 2.80 V, *D: 2.70 V to 3.63 \					
Output load cor	ndition	L_CMOS		15	oF Max.	-					
Innut voltage		VIH		70 % \	/cc Min.	05 05					
Input voltage		VIL		30 % V	cc Max.		OE or ST				
	D-f#			3.0	ns Max.		fo > 40 MHz				
Rise and Fall	Default	1-45		6.0	ns Max.		fo≤40 MHz	20 % - 80 % Vcc.			
time	Fast	tr/tf		3.0	ns Max.		fo = 0.67 MHz to 17	70 MHz L_CMOS = 15 pF			
	Slow			10.0	ns Max.	fo = 0.67 MHz to 20 MHz					
Disable Time		t_stp		1	µs Max.		Measured from the time OE or \overline{ST} pin crosses 30 % V_{CC}				
Enable Time		t_sta		1	µs Max.		Measured from the	time OE pin crosses 70 % Vcc			
Resume Time		t_res		3 n	ns Max.		Measured from the time ST pin crosses 70 % Vcc				
Start-up time		t_str		3 n	ns Max.		Measured from the time Vcc reaches its rated minimum value, 1.62 V				
Frequency agin	ıg	f_aging	This is ir	ncluded in frequer	ncy tolerance spe	cification.	+25 °C, first year				

^{*1} Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage variation, reflow drift, load drift and aging (+25 °C, 1 year).

Pin description

	•								
Pin	Name	I/O type	Function						
	OE	Innut	Output enable	High: Specified frequency output from OUT pin					
	UE	OE Input		Low: Out pin is low (weak pull down), only output driver is disabled.					
1				High: Specified frequency output from OUT pin					
	ST	Input	Standby	Low: Out pin is low (weak pull down),					
				Device goes to standby mode. Supply current reduces to the least as I std.					
2	GND	Power	Ground						
3	OUT	Output	Clock output	<u> </u>					
4	V _{cc}	Power	Power supply						

Product Name

SG-8101CG 170.000000MHz T C H P A 3

45678

②Package type CA: 7.0 mm x 5.0 mm CB: 5.0 mm x 3.2 mm CE: 3.2 mm x 2.5 mm

CG: 2.5 mm x 2.0 mm

Supply voltage T: 1.8 V to 3.3 V Typ.

©Operating temperature G: -40 ° C to +85 ° C H: -40 ° C to +105 ° C

8 Rise/Fall time A: Default B: Fast C: Slow

1 Model, 2 Package type,

3Frequency, 4Supply voltage,

5Frequency tolerance, 6Operating temperature,

7Function, 8Rise/Fall time

(5)Fı	reque	ency tolerance
B: 1	15 x	10 ⁻⁶
C: 2	20 x	10 ⁻⁶
J: {	50 x	10⁻6

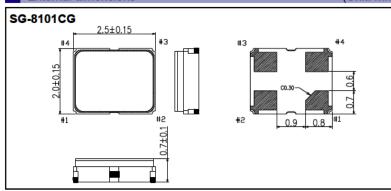
7Function P: Output Enable S: Standby

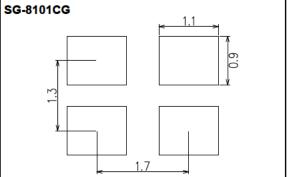
Available cor	mbination	tion CA: 7.0 mm x 5.0 mm CB: 5.0 mm x 3.2 mm CE: 3.2 mm x			3. 2 mm x 2.	2. 5 mm CG: 2.5 mm x 2.0			0 mm				
Frequency tolerance		B: 15 x 10 ⁻⁶	C: 20 x 10 ⁻⁶	J: 50 x 10 ⁻⁸	B: 15 x 10 ⁻⁶	C: 20 x 10 ⁻⁶	J: 50 x 10 ⁻⁸	B: 15 x 10 ⁻⁸	C: 20 x 10 ⁻⁸	J: 50 x 10 ⁻⁸	B: 15 x 10 ⁻⁸	C: 20 x 10 ⁻⁸	J: 50 x 10 ⁻⁸
	G: -40 °C to +85 °C	✓			✓			✓			✓		
temperatur	H: -40 °C to +105 °C		✓	✓		✓	~		✓	~		~	√

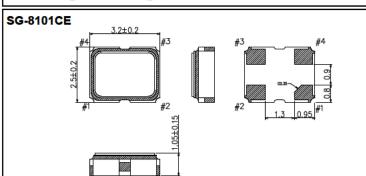
External dimensions

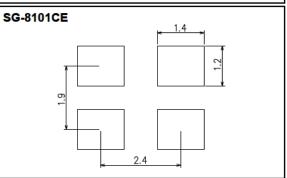
(Unit: mm)

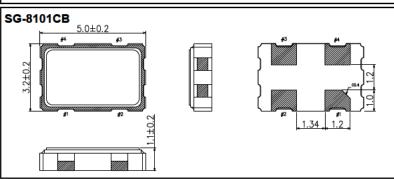
Footprint (Recommended) (Unit: mm)

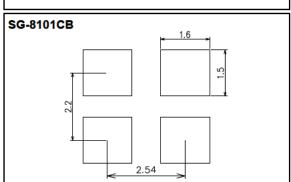


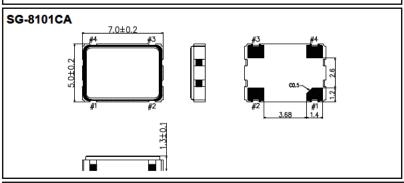


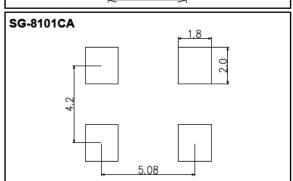












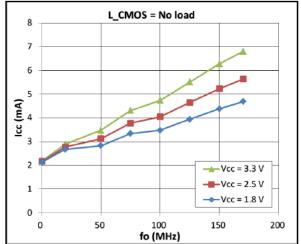
■Notes:

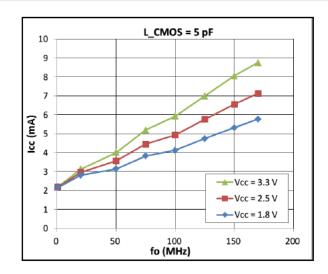
In order to achieve optimum jitter performance, the 0.1 μF capacitor between V_{CC} and GND should be placed. It is also recommended that the capacitors are placed on the device side of the PCB, as close to the device as possible and connected together with short wiring pattern.

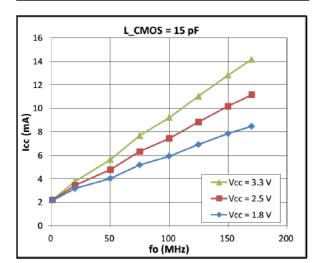


Specification Graph (Typical supplemental specification. Unless otherwise specified T_use = 25 °C, L_CMOS = 15 pF)

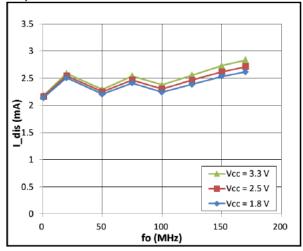
Current Consumption



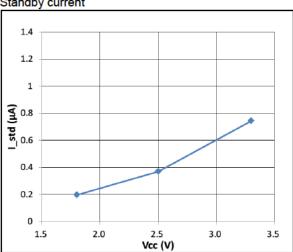




Output disable current



Standby current

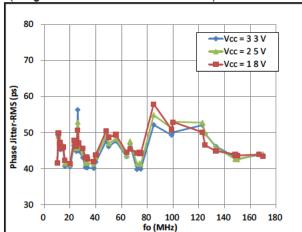


■Notes:

Specification Graph (Typical supplemental specification. Unless otherwise specified T_use = 25 °C, L_CMOS = 15 pF)

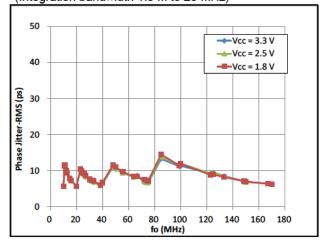
Phase Jitter RMS



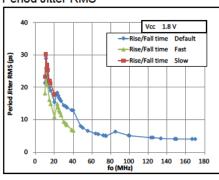


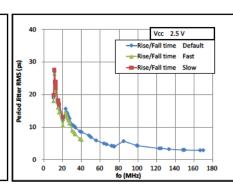
Phase Jitter RMS

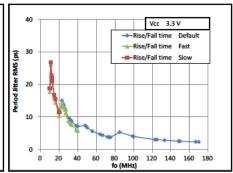
(Integration bandwidth 1.8 M to 20 MHz)



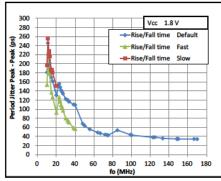
Period Jitter RMS

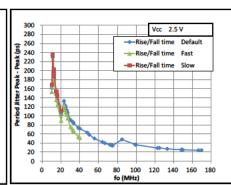


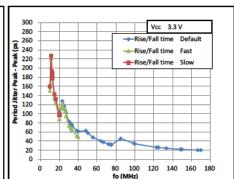




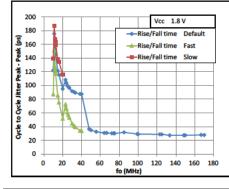
Period Jitter Peak-Peak

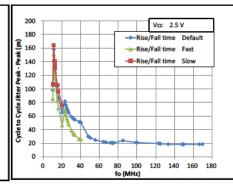


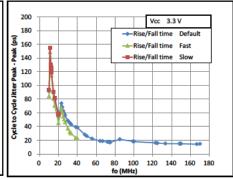




Cycle-to-Cycle Jitter Peak-Peak







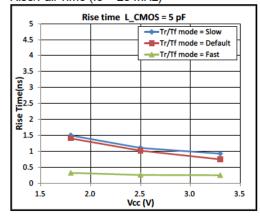
■ Notes:

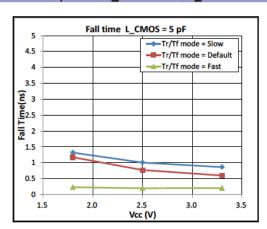


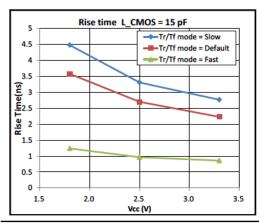
Specification Graph

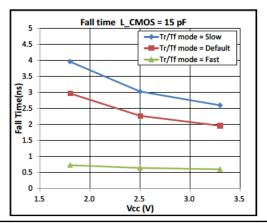
(Typical supplemental specification. Unless otherwise specified T_use = 25 °C, L_CMOS = 15 pF, Vcc = 3.3 V)

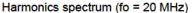
Rise/Fall Time (fo = 20 MHz)

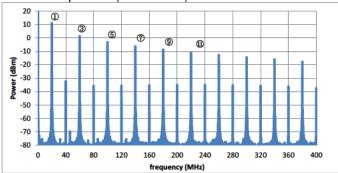




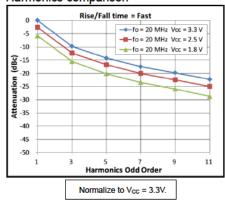


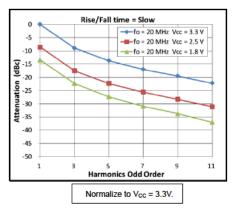


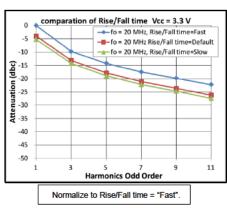




Harmonics comparison







■Notes:

٠.				
	frequency	slow	default	fast
	0.67 M - 20 MHz	See Slow	See Default	See Fast
	20 M – 40 MHz	-	See Default	See Fast
	40 M - 170 MHz	-	See Fast	See Fast



ESD Rating

Leb rating	
Test items	Breakdown voltage
Human Body Model (HBM)	2000 ∨
Machine Model (MM)	250 ∨
Charged Device Model (CDM)	750 ∨

Device Marking (Standard specification)

	Bovice Marking (Standard Specification)									
Model	Factory Programmed Part Marking	Field Programmable Part Marking (Blank Samples)								
SG-8101CG	Frequency Product code 170. A1 OA23DK 1pin mark Lot No.	A1 OA23DK Lot No.								
SG-8101CE	Frequency 170.0A1 o A23DK Lot No.	A1 o A23DK Lot No.								
SG-8101CB	Frequency 170.0A1 o A23DK 1pin mark Lot No.	A1 A23DK A23DK Lot No.								
SG-8101CA	Frequency 170.00A1 A23DK 1pin mark Lot No.	A1 O A23DK Lot No.								

Simulation Model

IBIS Model is available upon request. Please contact us.
 Information Required: Oscillator operating condition (i.e. Power Supply, Rise/Fall Time, Temperature)

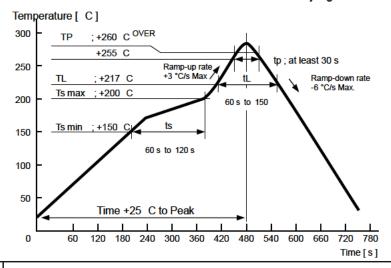


Device Material & Environmental Information

Model	Package	# of	Reference	Terminal	Terminal	Complies	Pb	MSL	Peak Temp.
	Dimensions	Pins	Weight	Material	Plating	With EU	Free	Rating	(Max)
			(Typ.)			RoHS			
SG-8101CG	2.5 x 2.0 x 0.7 mm	4	13 mg	W	Au	Yes	Yes	1	260 °C
SG-8101CE	3.2 x 2.5 x 1.0 mm	4	25 mg	W	Au	Yes	Yes	1	260 °C
SG-8101CB	5.0 x 3.2 x 1.1 mm	4	51 mg	W	Au	Yes	Yes	1	260 °C
SG-8101CA	7.0 x 5.0 x 1.3 mm	4	143 mg	W	Au	Yes	Yes	1	260 °C

SMD products Reflow profile(example)

The availability of the heat resistance for reflow conditions of JEDEC-STD-020D.01 is judged individually. Please inquire.





Pb free.



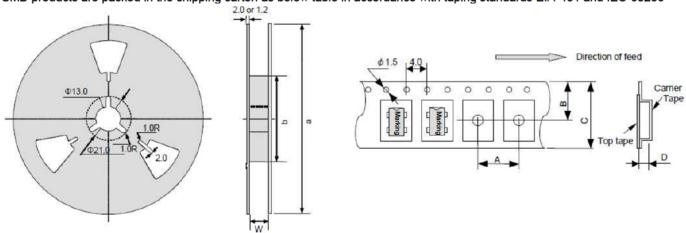
- Complies with EU RoHS directive.
 - About the products without the Pb-free mark.

 Contains Pb in products exempted by EU RoHS directive.

 (Contains Pb in sealing glass, high melting temperature type solder or other.)

Standard Packing Specification

SMD products are packed in the shipping carton as below table in accordance with taping standards EIA-481 and IEC-60286



Standard Packing Quantity & Dimension(Unit mm)

Model	Quantity	Re	el Dimensi	on	(Career Tape	Direction of Feed		
Model	(pcs/Reel)	а	b	W	Α	В	С	D	(L= Left Direction)
SG-8101CG	3000	Ф180	Ф60	9	4	5.25	8	1.15	L
SG-8101CE	2000	Ф180	Ф60	9	4	5.25	8	1.4	L
SG-8101CB	1000	Ф180	Ф60	13	8	7.25	12	1.4	L
SG-8101CA	1000	Ф254	Ф100	17.5	8	9.25	16	2.3	L

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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8N4Q001LG-1033CDI DSC8121CL5T DS1090U-2/V+T DS1090U-32+T DSC8121AM2 DSC8001AL2 DSC8101BL2 DSC8121CI1

DSC8124CI5 DSC8003CI2T DSC8102DI2 DSC8124CI2 DSC8123CI5 DSC8124BI2 DSC8122BI5 DSC8101DI2 DSC8121CL5 SG
8002JA 20.000M-PTMB-ROHS ECS-P143-10-AN 570FCC001204DG 570FCC000169DG 544BAEB002025CBG 544BAHB002172BBGR

544BAHB002157BBGR DS1077LU-40+T SiT3808AI-D2-XXXXX-000.FP000X DS1090U-1+T DS1086Z+T&R DS1087LU-447+T

544BCAA000112BBG DS1086LU+T 564BACA001478ABG SG-8018CG-PWT BLANK SG-8002CA 2.4576M-PCBB

564BACA000121ABG 564BACA001478BBG 564BABA002053ABG 564BAAA000121ABG 564BAAC000115BBG

564BAAD000115BBG ECS-P8F3X-1.000-AN 570CBC000306DG SiT8008AC-33-18E-33.333330 SiT8008AI-73-33E-20.000000